

BCR20KM-12L

Triac

Medium Power Use

REJ03G0329-0200 Rev.2.00 Nov.09.2004

Features

I_{T (RMS)}: 20 A
 V_{DRM}: 600 V

• I_{FGTI} , I_{RGTI} , I_{RGT} : 30 mA (20 mA)^{Note 5}

• Viso: 2000 V

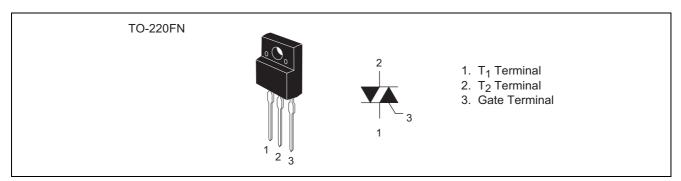
Insulated Type

• Planar Passivation Type

• UL Recognized: Yellow Card No. E223904

File No. E80271

Outline



Applications

Vacuum cleaner, electric heater, light dimmer, copying machine, and other general controlling devices

Maximum Ratings

Parameter	Symbol	Voltage class	- Unit	
Faianietei	Symbol	12		
Repetitive peak off-state voltage ^{Note1}	V_{DRM}	600	V	
Non-repetitive peak off-state voltage ^{Note1}	V_{DSM}	720	V	

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Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	I _{T (RMS)}	20	А	Commercial frequency, sine full wave 360° conduction, Tc = 85°C
Surge on-state current	I _{TSM}	200	А	60Hz sinewave 1 full cycle, peak value, non-repetitive
I ² t for fusing	l ² t	167	A ² s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	P_{GM}	5	W	
Average gate power dissipation	P _{G (AV)}	0.5	W	
Peak gate voltage	V_{GM}	10	V	
Peak gate current	I _{GM}	2	Α	
Junction temperature	Tj	- 40 to +125	°C	
Storage temperature	Tstg	- 40 to +125	°C	
Mass	_	2.0	g	Typical value
Isolation voltage	Viso	2000	V	Ta = 25°C, AC 1 minute, $T_1 \cdot T_2 \cdot G$ terminal to case

Notes: 1. Gate open.

Electrical Characteristics

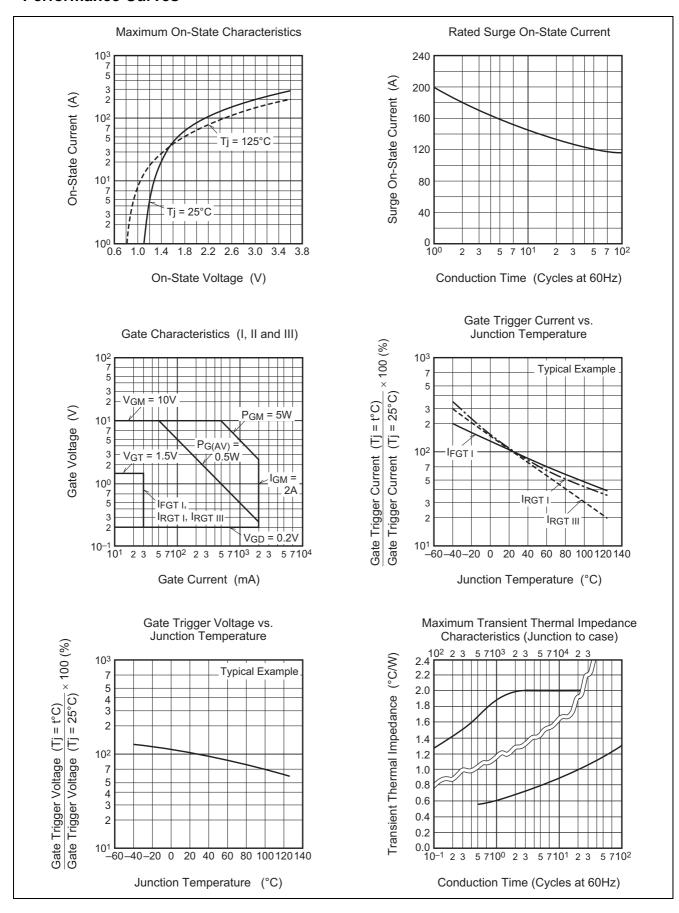
Parameter		Symbol	Min.	Тур.	Max.	Unit	Test conditions
Repetitive peak off-state current		I _{DRM}	_	_	2.0	mA	Tj = 125°C, V _{DRM} applied
On-state voltage		V_{TM}	_	_	1.5	V	Tc = 25°C, I _{TM} = 30 A, Instantaneous measurement
Gate trigger voltage ^{Note2}	I	V_{FGTI}	_	_	1.5	V	$Tj = 25$ °C, $V_D = 6$ V, $R_L = 6$ Ω,
	II	V_{RGTI}	_	_	1.5	V	$R_G = 330 \Omega$
	III	V_{RGTIII}	_	_	1.5	V	
Gate trigger current ^{Note2}	I	I_{FGTI}	_	_	30 ^{Note5}	mA	$Tj = 25$ °C, $V_D = 6$ V, $R_L = 6$ Ω,
	II	I_{RGTI}	_	_	30 ^{Note5}	mA	$R_G = 330 \Omega$
	III	I _{RGTIII}	_	_	30 ^{Note5}	mA	
Gate non-trigger voltage		V_{GD}	0.2	_	_	V	$Tj = 125^{\circ}C, V_D = 1/2 V_{DRM}$
Thermal resistance		R _{th (j-c)}	_	_	2.0	°C/W	Junction to case ^{Note3}
Critical-rate of rise of off-state commutating voltage ^{Note4}		(dv/dt)c	10	_	_	V/μs	Tj = 125°C

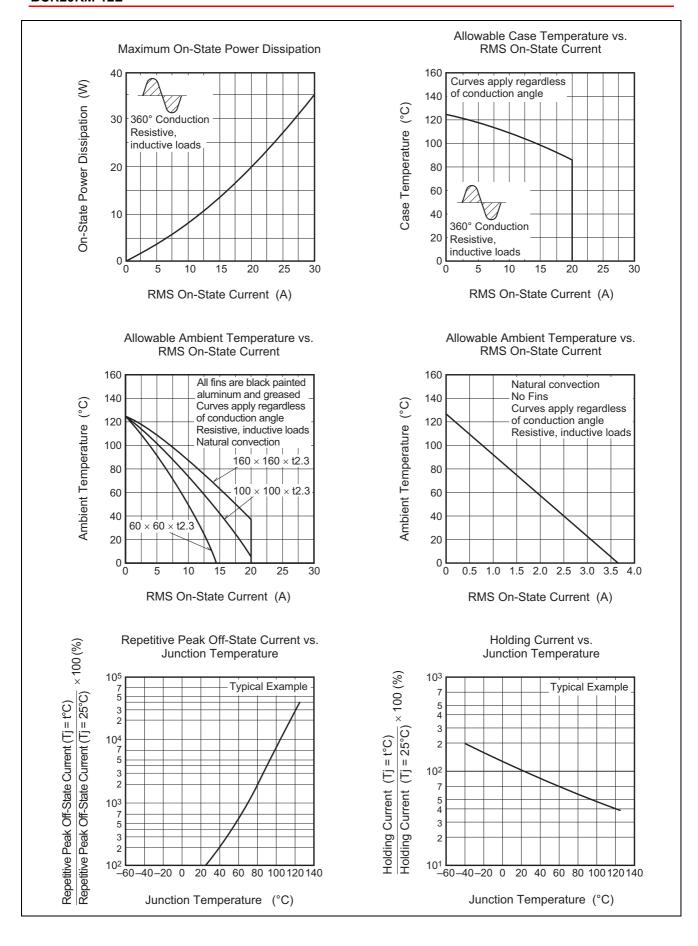
Notes: 2. Measurement using the gate trigger characteristics measurement circuit.

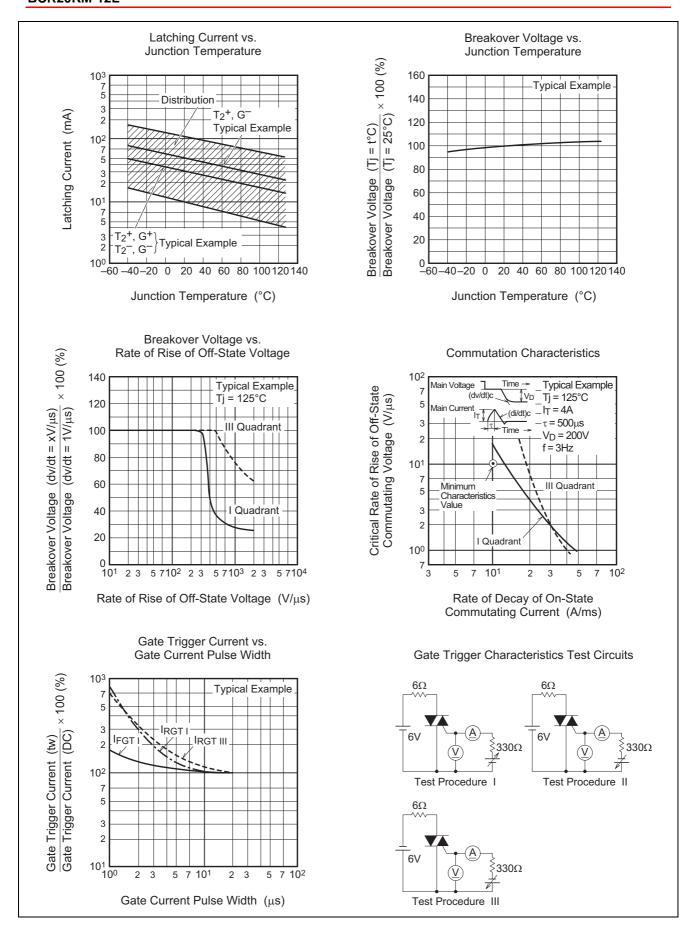
- 3. The contact thermal resistance $R_{th\ (c\text{-}f)}$ in case of greasing is 0.5°C/W.
- 4. Test conditions of the critical-rate of rise of off-state commutating voltage is shown in the table below.
- 5. High sensitivity ($I_{GT} \le 20$ mA) is also available. (I_{GT} item: 1)

Test conditions	Commutating voltage and current waveforms (inductive load)		
1. Junction temperature Tj = 125°C	Supply Voltage → Time		
2. Rate of decay of on-state commutating current (di/dt)c = -10 A/ms	Main Current (di/dt)c Time		
3. Peak off-state voltage $V_D = 400 \text{ V}$	Main Voltage Time		

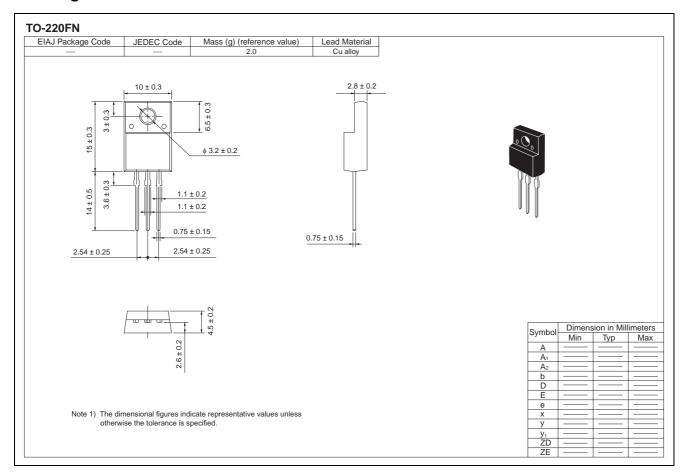
Performance Curves







Package Dimensions



Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Plastic Magazine (Tube)	50	Type name +A	BCR20KM-12LA
Lead form	Plastic Magazine (Tube)	50	Type name +A – Lead forming code	BCR20KM-12LA-A8

Note: Please confirm the specification about the shipping in detail.

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